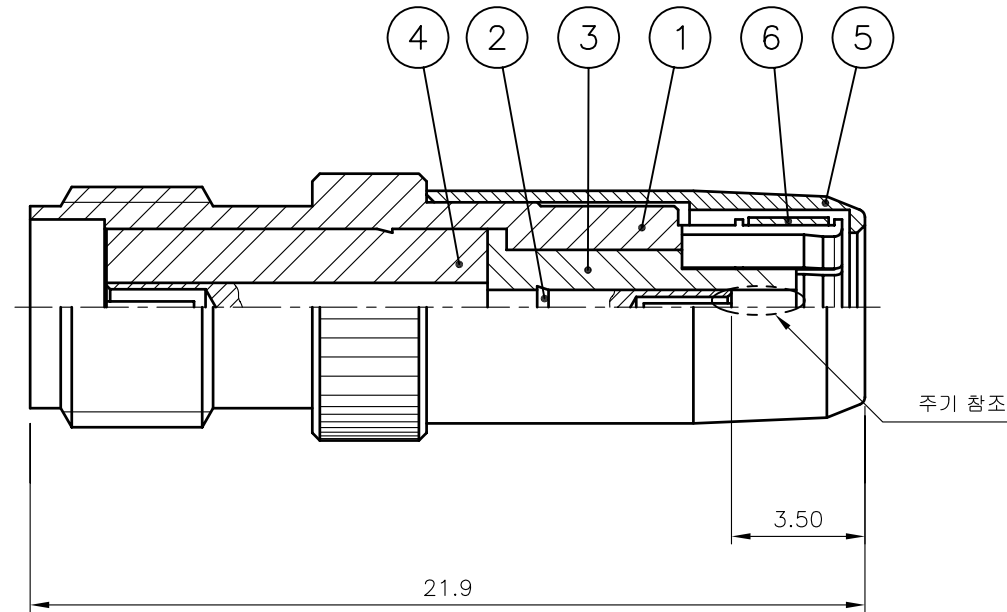


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.03.05.
1	[설번처리No.201811-0001] 절연체 분할 구조 변경	I.C.KIM		2018.11.13.



주기

1. 센타핀길이가 정상품과 비교 길이차이 및
암페놀 핀밀림 검출용으로 설계함
2. PIN 조립 시 ③번 절연체 밀림 없는지 확인 후 조립 할 것
(밀림 발생시 하단 지그대고 작업)

6	SPRLNG RING	1	BeCu	Copper Plate	DSR00009-5/1
5	CAP	1	MBsBD	Gold Plate	DCU02195-5/2
4	INSULATOR	1	TEFLON		DIN01014-N/1
3	INSULATOR	1	TEFLON		DAI00119-N/1
2	CONTACT	1	BeCu	Gold Plate	DAC03233-5/1
1	BODY	1	MBsBD	Gold Plate	DAD00212-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2018. 11. 13.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	±0.1	APPROVED BY			
	Angle				
MATERIAL	±1°	CHECKED BY		TITLE SMA50 (J) SMB50 (P) ST ADAPTOR	

FINISH	_____	DRAWN BY		A4	
	_____	I.C.KIM			
		SCALE	UNIT	DWG NO. AD00188-7/4	
		5/1	mm	REVISION 1	
				SHEET 1 of 1	